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3-STATE Quad Buffers MM74HC125, MM74HC126

General Description

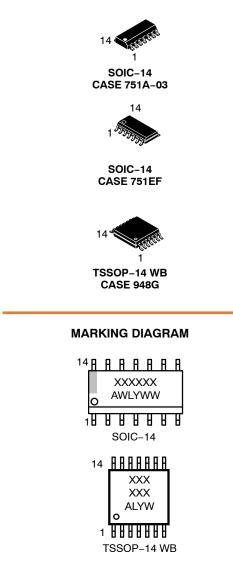
The MM74HC125 and MM74HC126 are general purpose 3–STATE high speed non–inverting buffers utilizing advanced silicon–gate CMOS technology. They have high drive current outputs which enable high speed operation even when driving large bus capacitances. These circuits possess the low power dissipation of CMOS circuitry, yet have speeds comparable to low power Schottky TTL circuits. Both circuits are capable of driving up to 15 low power Schottky inputs.

The MM74HC125 require the 3–STATE control input C to be taken high to put the output into the high impedance condition, whereas the MM74HC126 require the control input to be low to put the output into high impedance.

All inputs are protected from damage due to static discharge by diodes to VCC and ground.

Features

- Typical Propagation Delay: 13 ns
- Wide Operating Voltage Range: 2 V 6 V
- Low Input Current: 1 µA Maximum
- Low Quiescent Current: 160 µA maximum (74HC Series)
- Fanout of 15 LS-TTL Loads
- These Devices are Pb-Free, Halide Free and are RoHS Compliant

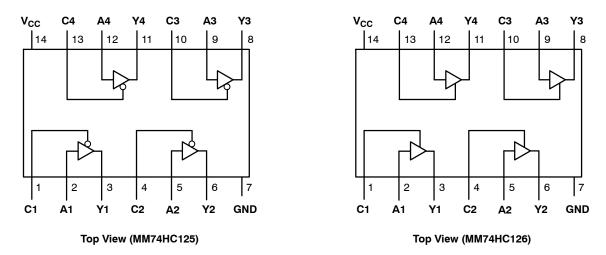


XXXXX = Specific Device Code A = Assembly Location WL, L = Wafer Lot Y = Year WW, W = Work Week

ORDERING INFORMATION

See detailed ordering and shipping information on page 6 of this data sheet.

Connection Diagram





TRUTH TABLE (MM74HC125)

Inp	Output	
Α	С	Y
Н	L	Н
L	L	L
Х	Н	Z

TRUTH TABLE (MM74HC126)

Inp	Output	
Α	С	Y
Н	Н	Н
L	Н	L
Х	L	Z

ABSOLUTE MAXIMUM RATINGS (Note 1)

Symbol	Parameter	Rating
V _{CC}	Supply Voltage	–0.5 to +6.5 V
V _{IN}	DC Input Voltage	–0.5 to V _{CC} + 0.5 V
V _{OUT}	DC Output Voltage	–0.5 to V _{CC} + 0.5 V
I _{IK} , I _{OK}	Clamp Diode Current	±20 mA
I _{OUT}	DC Output Current, per Pin	35 mA
I _{CC}	DC V _{CC} or GND Current, per Pin	±70 mA
T _{STG}	Storage Temperature Range	–65°C to +150°C
PD	Power Dissipation SOIC TSSOP	1077 mW 833 mW
ΤL	Lead Temperature (Soldering 10 Seconds)	260°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Unless otherwise specified all voltages are referenced to ground.

RECOMMENDED OPERATING CONDITIONS

Symbol		Min	Max	Unit	
V _{CC}	Supply Voltage	2	6	V	
V _{IN} , V _{OUT}	DC Input or Output Voltage	C Input or Output Voltage			
T _A	Operating Temperature Range	-55	+125	°C	
t _r , t _f	Input Rise or Fall Time	nput Rise or Fall Time V _{CC} = 2.0 V		1000	ns
		V _{CC} = 4.5 V	-	500	ns
		V _{CC} = 6.0 V	-	400	ns

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

DC CHARACTERISTICS (Note 2)

				T _A =	25°C	T _A = −40°C to 85°C	T _A = −55°C to 125°C	
Symbol	Parameter	Conditions	V _{CC} (V)	Тур	G	uaranteed Li	mits	Unit
V _{IH}	Minimum HIGH Level Input		2.0	-	1.5	1.5	1.5	V
	Voltage		4.5	-	3.15	3.15	3.15	
			6.0	-	4.2	4.2	4.2	
V _{IL}	Maximum LOW Level Input		2.0	-	0.5	0.5	0.5	V
	Voltage		4.5	-	1.35	1.35	1.35	
			6.0	-	1.8	1.8	1.8	
V _{OH}	Minimum HIGH Level Output	$V_{IN} = V_{IH} \text{ or } V_{IL},$	2.0	2.0	1.9	1.9	1.9	V
	Voltage	I _{OUT} ≤ 20 μA	4.5	4.5	4.4	4.4	4.4	
			6.0	6.0	5.9	5.9	5.9	
		$V_{IN} = V_{IH} \text{ or } V_{IL},$ $ I_{OUT} \le 6.0 \text{ mA}$	4.5	4.2	3.98	3.84	3.7	
		$V_{IN} = V_{IH} \text{ or } V_{IL},$ $ I_{OUT} \le 7.8 \text{ mA}$	6.0	5.7	5.48	5.34	5.2	
V _{OL}	Maximum LOW Level Output	$V_{IN} = V_{IH} \text{ or } V_{IL},$	2.0	0	0.1	0.1	0.1	V
	Voltage	I _{OUT} ≤ 20 μA	4.5	0	0.1	0.1	0.1	
			6.0	0	0.1	0.1	0.1	
		$V_{IN} = V_{IH} \text{ or } V_{IL},$ $ I_{OUT} \le 6.0 \text{ mA}$	4.5	0.2	0.26	0.33	0.4	
		$V_{IN} = V_{IH} \text{ or } V_{IL},$ $ I_{OUT} \le 7.8 \text{ mA}$	6.0	0.2	0.26	0.33	0.4	
I _{OZ}	Maximum 3–STATE Output Leakage Current		6.0	-	±0.5	±5	±10	μΑ
I _{IN}	Maximum Input Current	$V_{IN} = V_{CC}$ or GND	6.0	-	±0.1	±1.0	±1.0	μA
Icc	Maximum Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0 \ \mu A$	6.0	-	8.0	80	160	μΑ

2. For a power supply of 5 V \pm 10% the worst case output voltages (V_{OH}, and V_{OL}) occur for HC at 4.5 V. Thus the 4.5 V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at V_{CC} = 5.5 V and 4.5 V respectively. (The V_{IH} value at 5.5 V is 3.85 V.) The worst case leakage current (I_{IN}, I_{CC}, and I_{OZ}) occur for CMOS at the higher voltage and so the 6.0 V values should be used.

Guaranteed Limit Symbol Parameter Conditions Тур Unit Maximum Propagation Delay Time 13 18 ns t_{PHL}, t_{PLH} t_{PZH} Maximum Output Enable Time to HIGH Level $R_L = 1 \ k\Omega$ 13 25 ns Maximum Output Disable Time from HIGH Level R_L = 1 k Ω , C_L = 5 pF 17 25 t_{PHZ} ns Maximum Output Enable Time to LOW Level $R_L = 1 \ k\Omega$ 18 25 t_{PZL} ns Maximum Output Disable Time from LOW Level $R_L = 1 \ k\Omega, \ C_L = 5 \ pF$ 13 25 ns t_{PLZ}

AC CHARACTERISTICS (V_{CC} = 5 V, T_A = 25°C, C_L = 45 pF, t_r = t_f = 6 ns)

AC CHARACTERISTICS (V_{CC} = 2.0 V to 6.0 V, C_L = 50 pF, t_r = t_f = 6 ns (unless otherwise specified))

				T _A =	25°C	T _A = −40°C to 85°C	T _A = −55°C to 125°C	
Symbol	Parameter	V _{CC} (V)	Conditions	Тур	Typ Guaranteed Limits		mits	Unit
t _{PHL} , t _{PLH}	Maximum Propagation Delay Time	2.0		40	100	125	150	ns
		4.5		14	20	25	30	
		6.0		12	17	21	25	
t _{PLH} , t _{PHL}	Maximum Propagation Delay Time	2.0	C _L = 150 pF,	35	130	163	195	ns
		4.5		14	26	33	39	
		6.0		12	22	28	39	
t _{PZH} , t _{PZL}	Maximum Output Enable Time	2.0	$R_L = 1 k\Omega$	25	125	156	188	ns
		4.5		14	25	31	38	
		6.0		12	21	26	31	
t _{PHZ} , t _{PLZ}	Maximum Output Disable Time	2.0	$R_L = 1 \ k\Omega$	25	125	156	188	ns
		4.5		14	25	31	38	
		6.0		12	21	26	31	
t _{PZL} , t _{PZH}	Maximum Output Enable Time	2.0	C _L = 150 pF,	35	140	175	210	ns
		4.5	$R_L = 1 k\Omega$	15	28	35	42	
		6.0		13	24	30	36	
t _{TLH} , t _{THL}	Maximum Output Rise and Fall Time	2.0	C _L = 50 pF	30	60	75	90	ns
		4.5		7	12	15	18	
		6.0		6	10	13	15	
C _{IN}	Input Capacitance			5	10	10	10	pF
C _{OUT}	Output Capacitance Outputs			15	20	20	20	pF
C _{PD}	Power Dissipation Capacitance		Enabled	45	-	-	-	pF
	(per gate) (Note 3)		Disabled	6	-	-	-	

3. C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} V_{CC} f + I_{CC}$.

ORDERING INFORMATION

Part Number	Marking	Package	Shipping [†]
MM74HC125M	HC125A	SOIC-14, Case 751A (Pb-Free, Halide Free)	55 Units / Tube
MM74HC125MX	HC125A	SOIC-14, Case 751A (Pb-Free, Halide Free)	2500 / Tape & Reel
MM74HC125MTC	HC 125A	TSSOP-14, Case 948G (Pb-Free, Halide Free)	96 Units / Tube
MM74HC125MTCX	HC 125A	TSSOP-14 WB, Case 948G (Pb-Free, Halide Free)	2500 / Tape & Reel
MM74HC126M	HC126A	SOIC-14, Case 751A (Pb-Free, Halide Free)	55 Units / Tube
MM74HC126MX	HC126A	SOIC-14, Case 751EF (Pb-Free, Halide Free)	2500 / Tape & Reel
MM74HC126MTCX	HC 126A	TSSOP-14 WB, Case 948G (Pb-Free, Halide Free)	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NOTE: Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.

DUSEU

0.068

0.019

0.344

0.244



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DATE 03 FEB 2016

STYLE 1: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. NO CONNECTION 7. ANODE/CATHODE 8. ANODE/CATHODE 9. ANODE/CATHODE 10. NO CONNECTION 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 2: CANCELLED	STYLE 3: PIN 1. NO CONNECTION 2. ANODE 3. ANODE 4. NO CONNECTION 5. ANODE 6. NO CONNECTION 7. ANODE 8. ANODE 9. ANODE 10. NO CONNECTION 11. ANODE 12. ANODE 13. NO CONNECTION 14. COMMON CATHODE	STYLE 4: PIN 1. NO CONNECTION 2. CATHODE 3. CATHODE 4. NO CONNECTION 5. CATHODE 6. NO CONNECTION 7. CATHODE 9. CATHODE 10. NO CONNECTION 11. CATHODE 12. CATHODE 13. NO CONNECTION 14. COMMON ANODE
STYLE 5: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. NO CONNECTION 7. COMMON ANODE 8. COMMON CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 6: PIN 1. CATHODE 2. CATHODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE 7. CATHODE 8. ANODE 9. ANODE 10. ANODE 11. ANODE 12. ANODE 13. ANODE 14. ANODE	STYLE 7: PIN 1. ANODE/CATHODE 2. COMMON ANODE 3. COMMON CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 7. ANODE/CATHODE 8. ANODE/CATHODE 10. ANODE/CATHODE 11. COMMON CATHODE 12. COMMON ANODE 13. ANODE/CATHODE 14. ANODE/CATHODE	STYLE 8: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. ANODE/CATHODE 7. COMMON ANODE 8. COMMON ANODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. NO CONNECTION 12. ANODE/CATHODE 13. ANODE/CATHODE 14. COMMON CATHODE

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